

RoHS Compliant Product  
A suffix of "-C" specifies halogen & lead-free

## DESCRIPTION

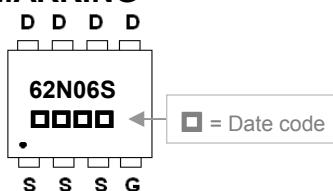
The SPR62N06S-C is the highest performance trench N-Ch MOSFETs with extreme high cell density, which provide excellent  $R_{DS(ON)}$  and gate charge for most of the synchronous buck converter applications.

The SPR62N06S-C meet the RoHS and Green Product requirement with full function reliability approved.

## FEATURES

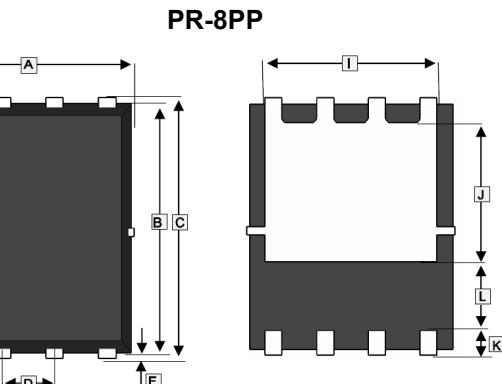
- Lower Gate Charge
- Advanced high cell density Trench technology
- Green Device Available

## MARKING

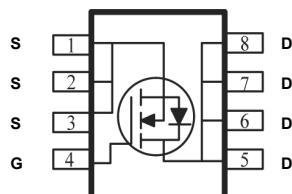


## PACKAGE INFORMATION

| Package | MPQ | Leader Size |
|---------|-----|-------------|
| PR-8PP  | 3K  | 13 inch     |



| REF. | Millimeter |      | REF. | Millimeter |      |
|------|------------|------|------|------------|------|
|      | Min.       | Max. |      | Min.       | Max. |
| A    | 4.9        | 5.1  | G    | 0.8        | 1.0  |
| B    | 5.7        | 5.9  | H    | 0.254      | Ref. |
| C    | 5.95       | 6.2  | I    | 4.0        | Ref. |
| D    | 1.27       | BSC. | J    | 3.4        | Ref. |
| E    | 0.35       | 0.49 | K    | 0.6        | Ref. |
| F    | 0.1        | 0.2  | L    | 1.4        | Ref. |



## ORDER INFORMATION

| Part Number | Type                            |
|-------------|---------------------------------|
| SPR62N06S-C | Lead (Pb)-free and Halogen-free |

## ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise specified)

| Parameter   | Symbol                        | Ratings  | Unit |
|---|-------------------------------|----------|------|
| Drain-Source Voltage                                    | $V_{DS}$                      | 60       | V    |
| Gate-Source Voltage                                     | $V_{GS}$                      | $\pm 20$ | V    |
| Continuous Drain Current <sup>1</sup> (Silicon Limited) | $I_D$ $T_C=25^\circ\text{C}$  | 62       | A    |
|   | $I_D$ $T_C=100^\circ\text{C}$ | 39       |      |
| Continuous Drain Current <sup>1</sup> (Package Limited) | $I_D$ $T_C=25^\circ\text{C}$  | 45       |      |
| Pulsed Drain Current <sup>2,4</sup>                     | $I_{DM}$                      | 270      | A    |
| Power Dissipation                                       | $P_D$ $T_C=25^\circ\text{C}$  | 62.5     | W    |
| Operating Junction & Storage Temperature                | $T_J, T_{STG}$                | -55~150  | °C   |
| Thermal Resistance Ratings                              |                               |          |      |
| Thermal Resistance Junction-Ambient <sup>1</sup>        | $R_{\theta JA}$               | 65       | °C/W |
| Thermal Resistance Junction-Case <sup>1</sup>           | $R_{\theta JC}$               | 2        |      |

**ELECTRICAL CHARACTERISTICS** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

| Parameter                                      | Symbol              | Min. | Typ. | Max.      | Unit | Test Conditions  |
|--|---------------------|------|------|-----------|------|--|
| Drain-Source Breakdown Voltage                 | $V_{(BR)DSS}$       | 60   | -    | -         | V    | $V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$  |
| Gate-Threshold Voltage                         | $V_{GS(\text{th})}$ | 1    | -    | 2.4       | V    | $V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$   |
| Gate-Source Leakage Current                    | $I_{GSS}$           | -    | -    | $\pm 100$ | nA   | $V_{GS}=\pm 20\text{V}$ , $V_{DS}=0\text{V}$                                     |
| Drain-Source Leakage Current                   | $I_{DSS}$           | -    | -    | 1         | uA   | $V_{DS}=48\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=25^\circ\text{C}$                |
|  |                     | -    | -    | 100       |      | $V_{DS}=48\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=100^\circ\text{C}$               |
|  |                     | -    | 7.3  | 9         | mΩ   | $V_{GS}=10\text{V}$ , $I_D=20\text{A}$   |
| Static Drain-Source On-Resistance <sup>3</sup> | $R_{DS(\text{ON})}$ | -    | 10   | 13        |      | $V_{GS}=4.5\text{V}$ , $I_D=20\text{A}$  |
|  |                     | -    | 26   | -         | S    | $V_{DS}=5\text{V}$ , $I_D=20\text{A}$  |
| Transconductance                               | $g_{fs}$            | -    | 1.5  | -         | Ω    | $V_{DS}=V_{GS}=0\text{V}$ , $f=1\text{MHz}$                                      |
| Total Gate Charge (4.5V)                       | $Q_g$               | -    | 12   | -         | nC   | $I_D=20\text{A}$<br>$V_{DD}=30\text{V}$<br>$V_{GS}=10\text{V}$                   |
| Total Gate Charge                              |                     | -    | 24   | -         |      |  |
| Gate-Source Charge                             | $Q_{gs}$            | -    | 5    | -         |      |  |
| Gate-Drain Change                              | $Q_{gd}$            | -    | 3    | -         |      |  |
| Turn-on Delay Time                             | $T_{d(\text{on})}$  | -    | 9    | -         | nS   | $V_{DD}=30\text{V}$<br>$I_D=20\text{A}$<br>$V_{GS}=10\text{V}$<br>$R_G=10\Omega$ |
| Rise Time                                      | $T_r$               | -    | 4    | -         |      |  |
| Turn-off Delay Time                            | $T_{d(\text{off})}$ | -    | 29   | -         |      |  |
| Fall Time                                      | $T_f$               | -    | 4    | -         |      |  |
| Input Capacitance                              | $C_{iss}$           | -    | 1620 | -         | pF   | $V_{GS}=0\text{V}$<br>$V_{DS}=30\text{V}$<br>$f=1\text{MHz}$                     |
| Output Capacitance                             | $C_{oss}$           | -    | 415  | -         |      |  |
| Reverse Transfer Capacitance                   | $C_{rss}$           | -    | 3    | -         |      |  |
| <b>Source-Drain Diode</b>                      |                     |      |      |           |      |  |
| Diode Forward Voltage <sup>3</sup>             | $V_{SD}$            | -    | -    | 1.2       | V    | $I_F=20\text{A}$ , $V_{GS}=0\text{V}$  |
| Reverse Recovery Time                          | $T_{rr}$            | -    | 30   | -         | nS   | $I_F=20\text{A}$ , $V_R=30\text{V}$ , $dI/dt=300\text{A}/\mu\text{s}$            |
| Reverse Recovery Charge                        | $Q_{rr}$            | -    | 43   | -         | nC   |  |

Notes:

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
2. The Pulse width limited by maximum junction temperature, Pulse Width  $\leq 10\mu\text{s}$ , Duty Cycle  $\leq 2\%$
3. The Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$
4. Package limit.

## CHARACTERISTIC CURVES

Fig 1. Typical Output Characteristics

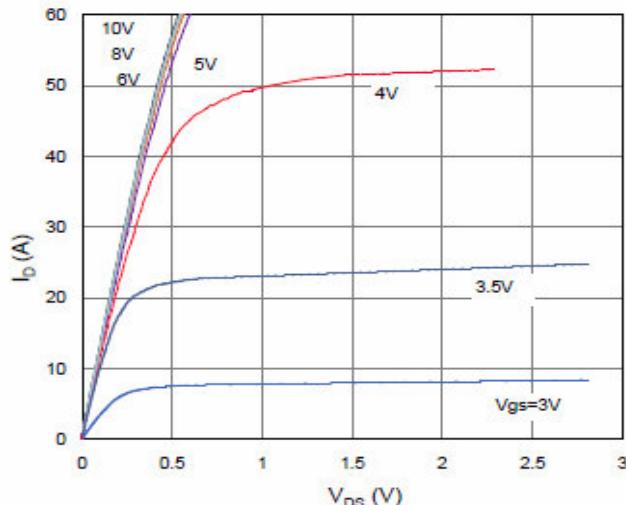


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

Figure 2. On-Resistance vs. Gate-Source Voltage

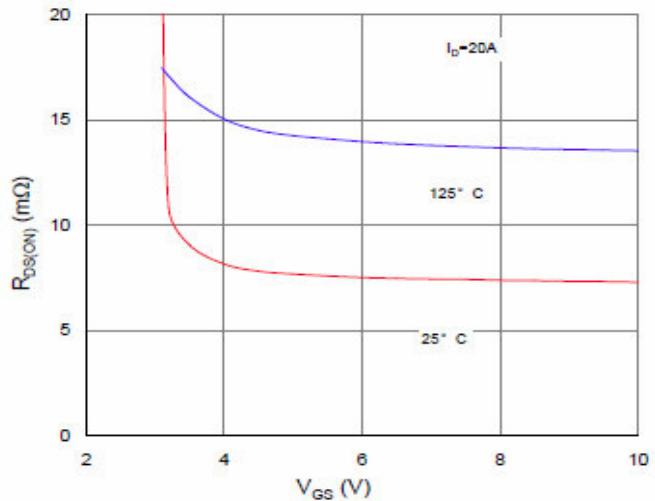


Figure 4. Normalized On-Resistance vs. Junction Temperature

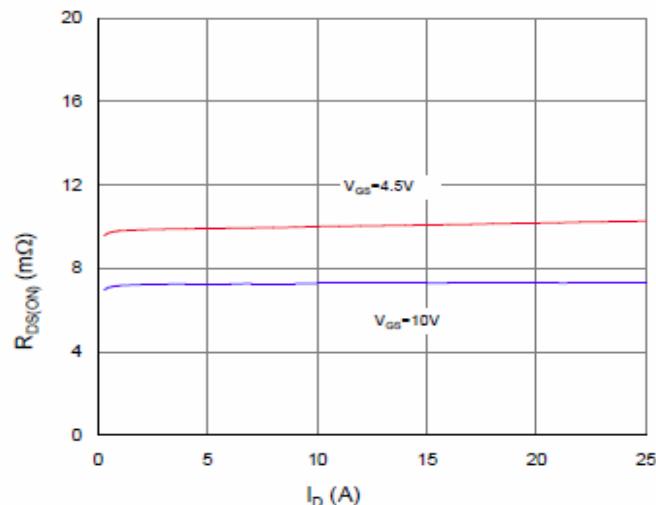


Figure 5. Typical Transfer Characteristics

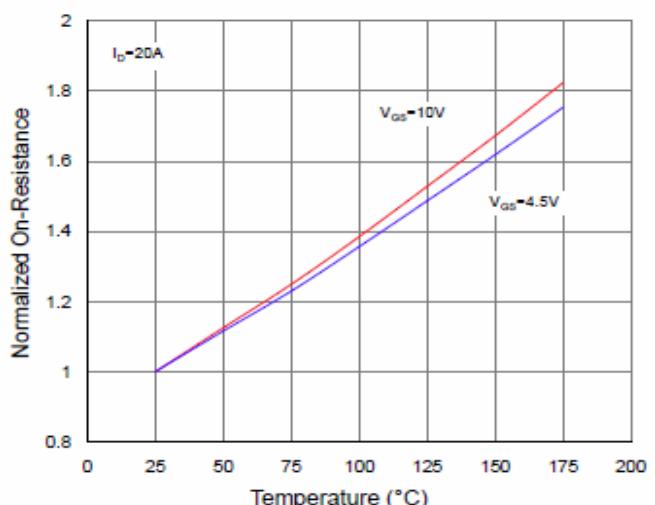
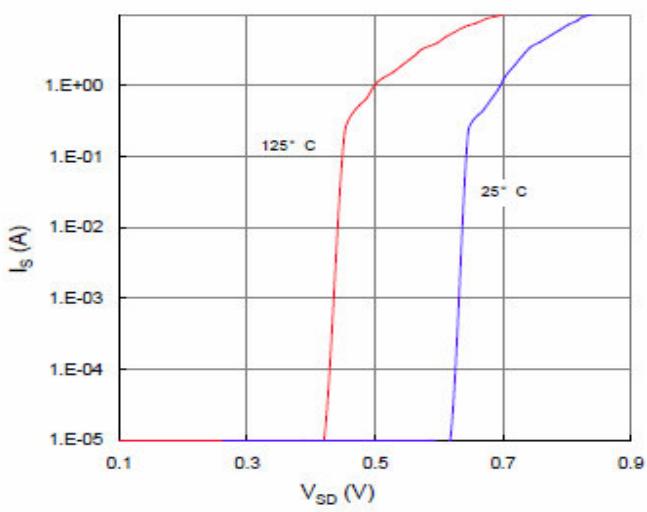
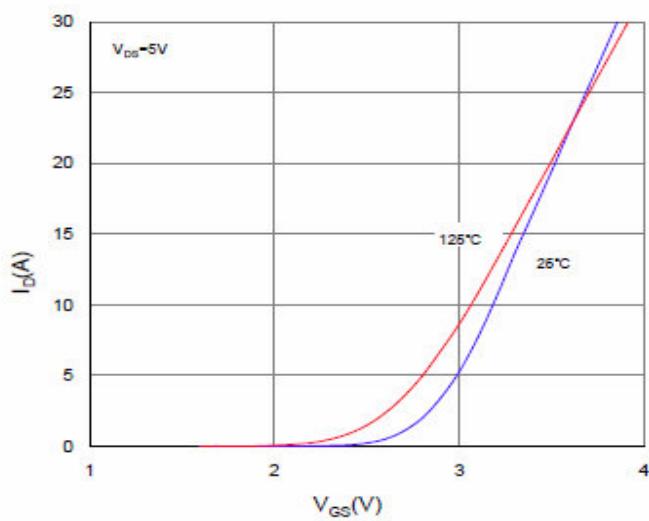


Figure 6. Typical Source-Drain Diode Forward Voltage



## CHARACTERISTIC CURVES

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

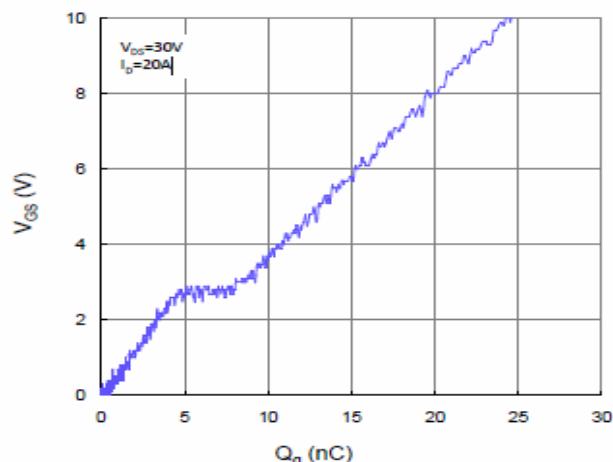


Figure 9. Maximum Safe Operating Area

Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

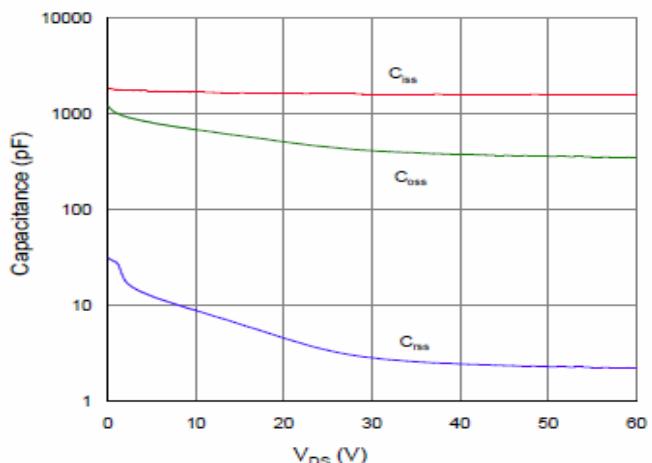


Figure 10. Maximum Drain Current vs. Case Temperature

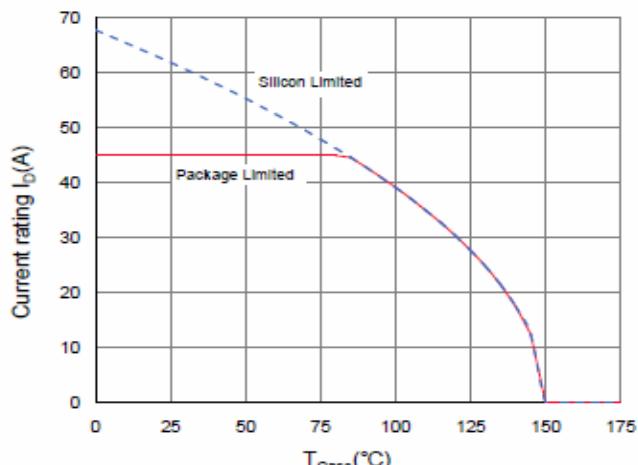
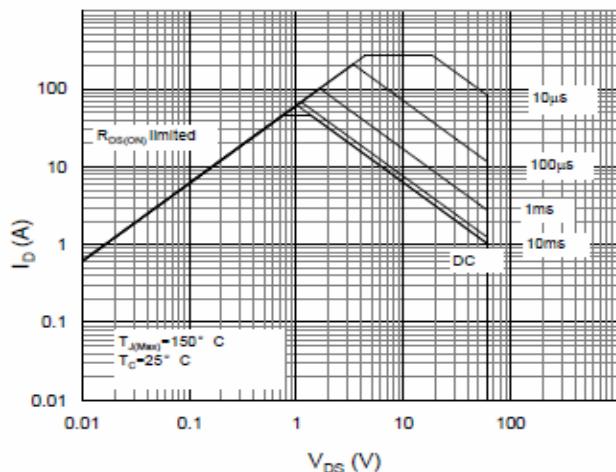


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case

